

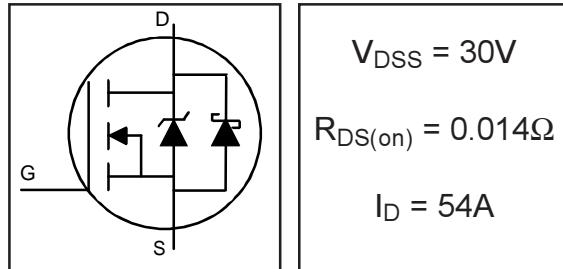
International **IR** Rectifier

PD-95435

IRL3103D2PbF

FETKY™ MOSFET & SCHOTTKY RECTIFIER

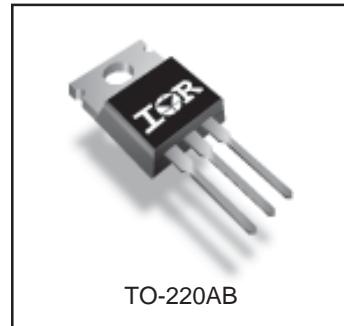
- Copackaged HEXFET® Power MOSFET and Schottky Diode
- Generation 5 Technology
- Logic Level Gate Drive
- Minimize Circuit Inductance
- Ideal For Synchronous Regulator Application
- Lead-Free



Description

The FETKY family of copackaged HEXFET power MOSFETs and Schottky Diodes offer the designer an innovative board space saving solution for switching regulator applications. A low on resistance Gen 5 MOSFET with a low forward voltage drop Schottky diode and minimized component interconnect inductance and resistance result in maximized converter efficiencies.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.



Absolute Maximum Ratings

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	54	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	34	
I_{DM}	Pulsed Drain Current ①	220	
$P_D @ T_A = 25^\circ C$	Power Dissipation	2.0	W
$P_D @ T_C = 25^\circ C$	Power Dissipation	70	W
	Linear Derating Factor	0.56	W/°C
V_{GS}	Gate-to-Source Voltage	± 16	V
T_J	Operating Junction and	-55 to + 150	°C
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	°C
	Mounting torque, 6-32 or M3 screw	10 lbf·in (1.1N·m)	

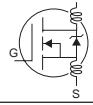
Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	1.8	°C/W
$R_{\theta JA}$	Junction-to-Ambient	—	62	

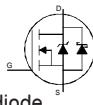
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MOSFET Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	30	—	—	V	$V_{\text{GS}} = 0\text{V}$, $I_D = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient	—	0.037	—	V/ $^\circ\text{C}$	Reference to 25°C , $I_D = 1\text{mA}$ ③
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-Resistance	—	—	0.014	Ω	$V_{\text{GS}} = 10\text{V}$, $I_D = 32\text{A}$ ②
		—	—	0.019		$V_{\text{GS}} = 4.5\text{V}$, $I_D = 27\text{A}$ ②
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	1.0	—	—	V	$V_{\text{DS}} = V_{\text{GS}}$, $I_D = 250\mu\text{A}$
g_f	Forward Transconductance	23	—	—	S	$V_{\text{DS}} = 25\text{V}$, $I_D = 34\text{A}$ ③
I_{DSS}	Drain-to-Source Leakage Current	—	—	0.25	mA	$V_{\text{DS}} = 30\text{V}$, $V_{\text{GS}} = 0\text{V}$
		—	—	35		$V_{\text{DS}} = 24\text{V}$, $V_{\text{GS}} = 0\text{V}$, $T_J = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{\text{GS}} = 16\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{\text{GS}} = -16\text{V}$
Q_g	Total Gate Charge	—	—	44	nC	$I_D = 32\text{A}$
Q_{gs}	Gate-to-Source Charge	—	—	14		$V_{\text{DS}} = 24\text{V}$
Q_{gd}	Gate-to-Drain ("Miller") Charge	—	—	24		$V_{\text{GS}} = 4.5\text{V}$, See Fig. 6 ②
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	9.0	—	ns	$V_{\text{DD}} = 15\text{V}$
t_r	Rise Time	—	210	—		$I_D = 34\text{A}$
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	20	—		$R_G = 3.4\Omega$, $V_{\text{GS}} = 4.5\text{V}$
t_f	Fall Time	—	54	—		$R_D = 0.43 \Omega$, ②③
L_D	Internal Drain Inductance	—	4.5	—	nH	Between lead, 6mm (0.25in.) from package and center of die contact
L_S	Internal Source Inductance	—	7.5	—		
C_{iss}	Input Capacitance	—	2300	—	pF	$V_{\text{GS}} = 0\text{V}$
C_{oss}	Output Capacitance	—	1100	—		$V_{\text{DS}} = 25\text{V}$
C_{rss}	Reverse Transfer Capacitance	—	310	—		$f = 1.0\text{MHz}$, See Fig. 5
C_{iss}	Input Capacitance	—	3500	—		$V_{\text{GS}} = 0\text{V}$, $V_{\text{DS}} = 0\text{V}$

Body Diode & Schottky Diode Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_F (\text{AV})$	(Schottky)	—	—	5.0	A	MOSFET symbol showing the integral reverse p-n junction and Schottky diode.
I_{SM}	Pulsed Source Current (Body Diode) ①	—	—	220		
$V_{\text{SD}1}$	Diode Forward Voltage	—	—	1.3	V	$T_J = 25^\circ\text{C}$, $I_S = 32\text{A}$, $V_{\text{GS}} = 0\text{V}$ ②
$V_{\text{SD}2}$	Diode Forward Voltage	—	—	0.6	V	$T_J = 25^\circ\text{C}$, $I_S = 3.0\text{A}$, $V_{\text{GS}} = 0\text{V}$ ②
t_{rr}	Reverse Recovery Time	—	51	77	ns	$T_J = 25^\circ\text{C}$, $I_F = 32\text{A}$
Q_{rr}	Reverse Recovery Charge	—	47	71	nC	$dI/dt = 100\text{A}/\mu\text{s}$ ②
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L_S+L_D)				

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 10)
- ② Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.
- ③ Uses IRL3103 data and test conditions

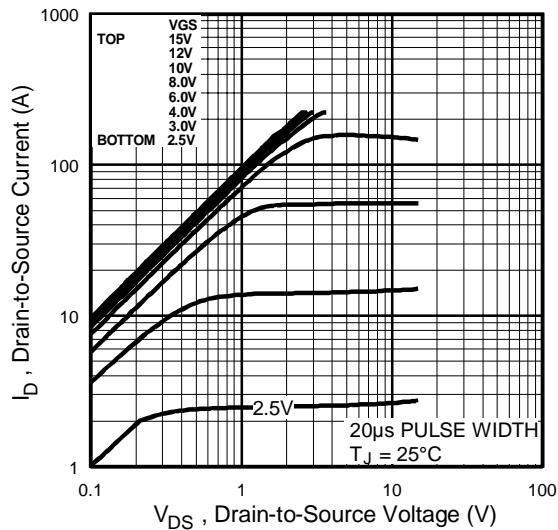


Fig 1. Typical Output Characteristics

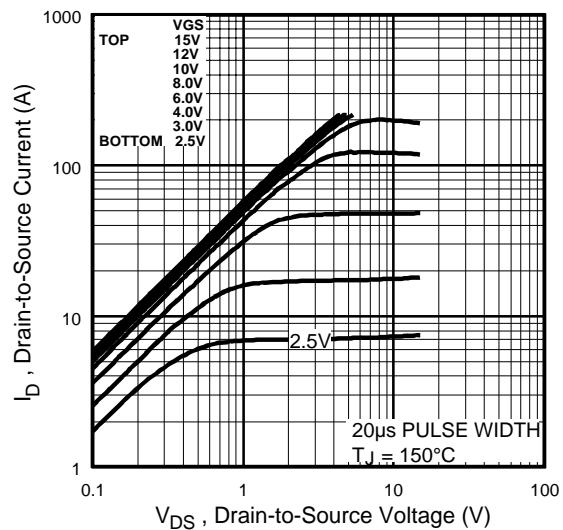


Fig 2. Typical Output Characteristics

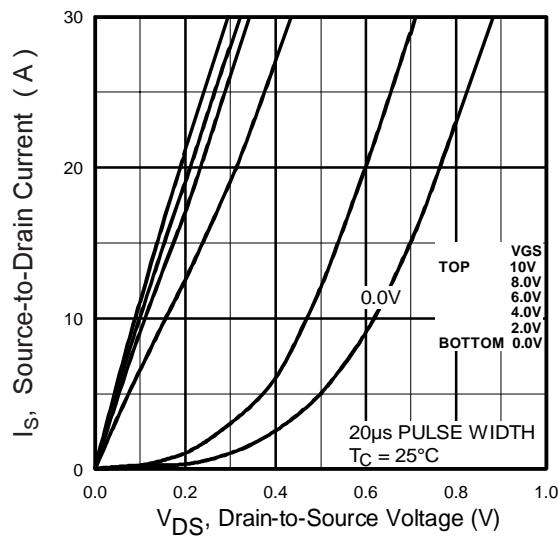


Fig 3. Typical Reverse Output Characteristics

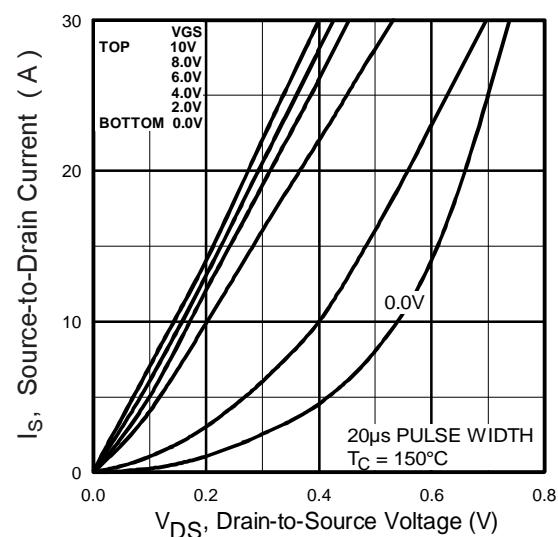


Fig 4. Typical Reverse Output Characteristics

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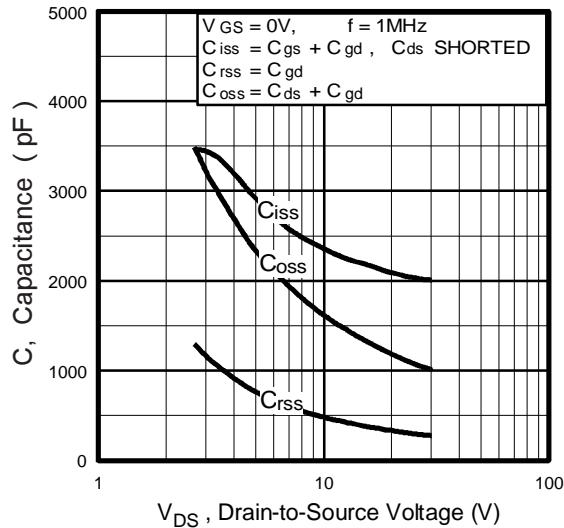


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

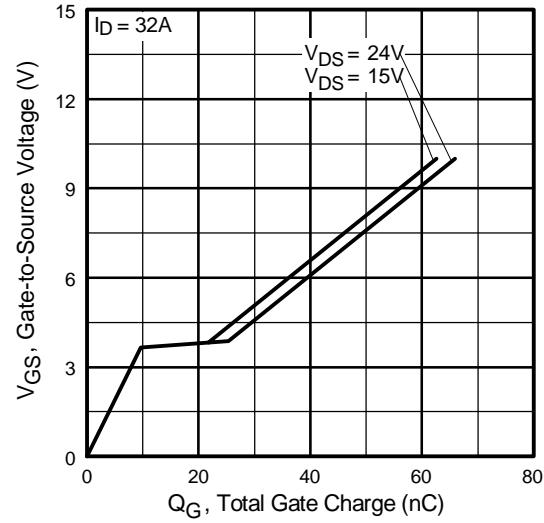


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

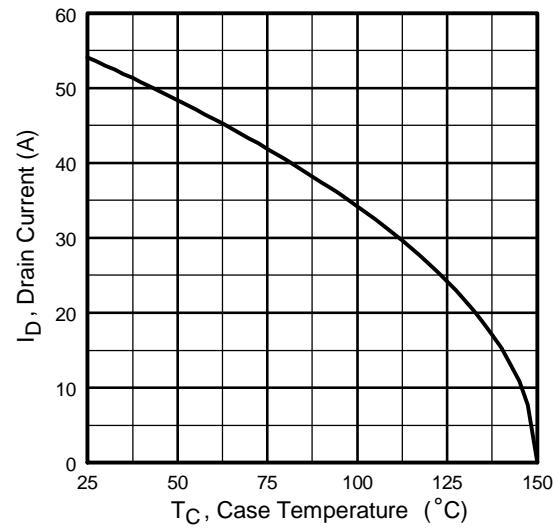


Fig 7. Maximum Drain Current Vs.
Case Temperature

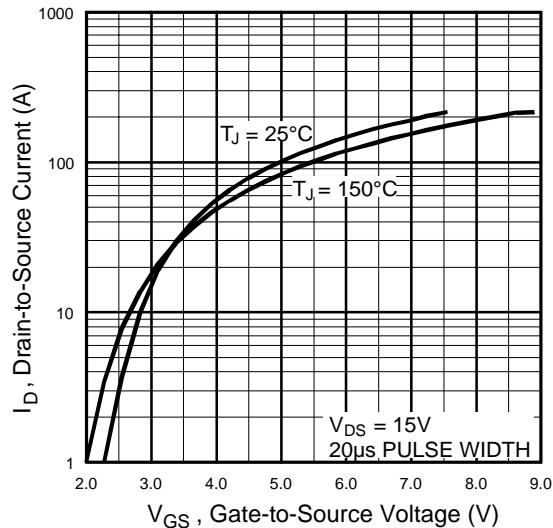


Fig 8. Typical Transfer Characteristics

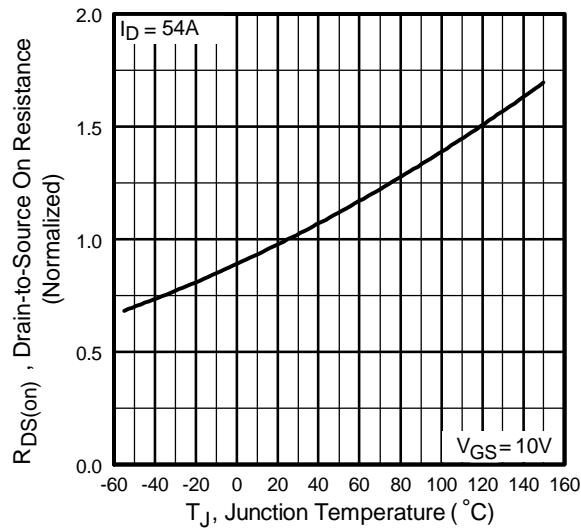


Fig 9. Normalized On-Resistance
Vs. Temperature

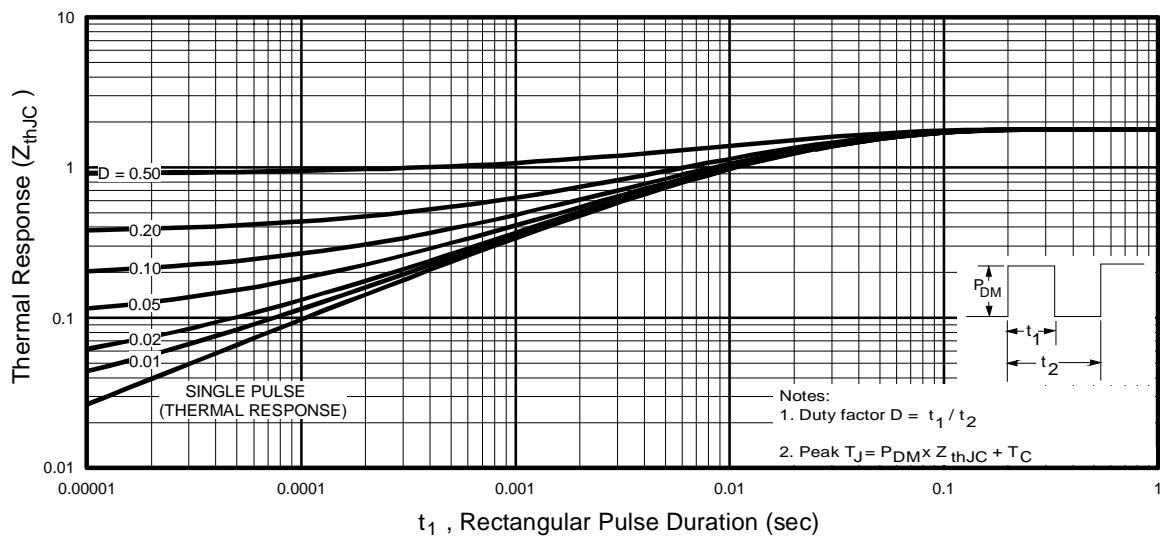


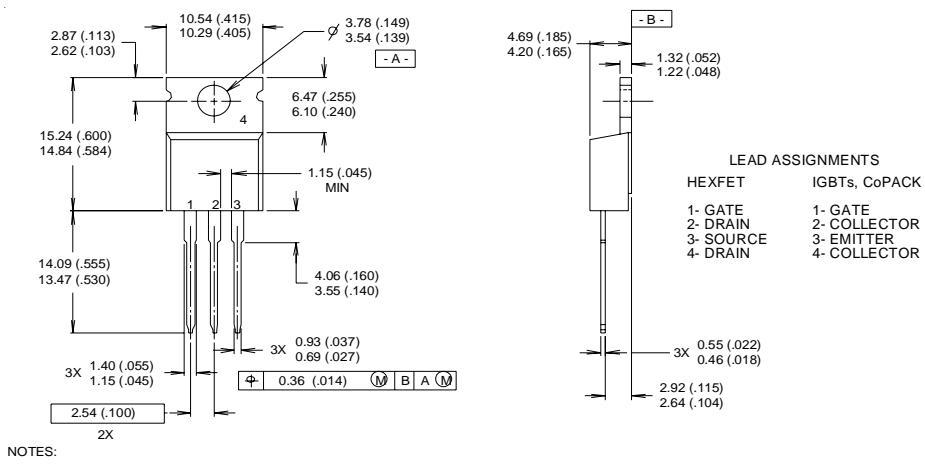
Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



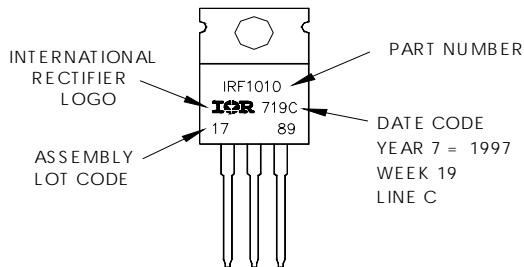
NOTES:

- 1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982.
- 2 CONTROLLING DIMENSION : INCH

- 3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB.
- 4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010
LOT CODE 1789
ASSEMBLED ON WW 19, 1997
IN THE ASSEMBLY LINE "C"
Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.

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Visit us at www.irf.com for sales contact information. 06/04

Note: For the most current drawings please refer to the IR website at:
<http://www.irf.com/package/>